



EGN13B200IV-R

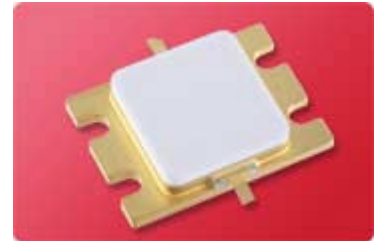
High Voltage - High Power GaN-HEMT for Radar

FEATURES

- High Voltage Operation : $V_{DS}=50V$
- High Power : 170W (min.) @ $P_{in}=4W$ (36dBm)
- High Efficiency: 55%(typ.) @ $P_{in}=4W$ (36dBm)

DESCRIPTION

Sumitomo GaN-HEMT EGN13B200IV-R offers high power, high efficiency, ease of matching and greater consistency covering 1.2 to 1.4GHz for L-band radar applications with 50V operation. The low thermal resistance allows to use long pulse up to 3 msec pulse width with duty of 10%.



ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Condition	Rating	Unit
Operating Voltage	V_{DS}		50	V
Drain-Source Voltage	V_{DS}	$V_{GS}=-5V$	120	V
Gate-Source Voltage	V_{GS}		- 5	V
Storage Temperature	T_{stg}		-65 to +100	°C
Channel Temperature	T_{ch}		250	°C

RECOMMENDED OPERATING CONDITION(Case Temperature $T_c= 25^\circ C$)

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	V_{DS}		≤ 50	V
Forward Gate Current	I_{GF}	$R_G=5.1 \Omega$	≤ 100	mA
Reverse Gate Current	I_{GR}	$R_G=5.1 \Omega$	≥ -14.4	mA
Pulse Width	PW	Duty 10%	≤ 3000	μsec
		Duty 25%	≤ 750	μsec
Peak Channel Temperature	$T_{ch-peak}$	Duty 10%	≤ 220	°C
		Duty 25%	≤ 205	°C

ELECTRICAL CHARACTERISTICS (Case Temperature $T_c=25^\circ C$)

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	V_p	$V_{DS}=50V$ $I_{DS}=72mA$	-1.0	-2.0	-3.5	V
Output Power	P_{out}	$V_{DS}=50V$	170	-	-	W
Drain Efficiency	η_d	$I_{DS(DC)}=1000mA$	-	55	-	%
Power Gain	G_p	$P_{in}=4W$ (36dBm)	16.3	-	-	dB
Gain Flatness	GF	$f=1.2, 1.3, 1.4GHz$ $PW=200\mu sec, Duty 10\%$	-	0.8	1.2	dB
Thermal Resistance	R_{th}	Channel to Case Measured w/CW at 90W P_{DC}	-	0.7	0.85	°C/W



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THERMAL CHARACTERISTICS IN PULSED RF OPERATION

Transient Thermal Resistance, Channel to Case,	Typ.	Unit
Case Temperature 75°C, Pulse Width 200μsec , Duty 10%	0.19	°C/W
Case Temperature 75°C, Pulse Width 3000μsec , Duty 10%	0.42	°C/W
Case Temperature 75°C, Pulse Width 750μsec , Duty 25%	0.39	°C/W

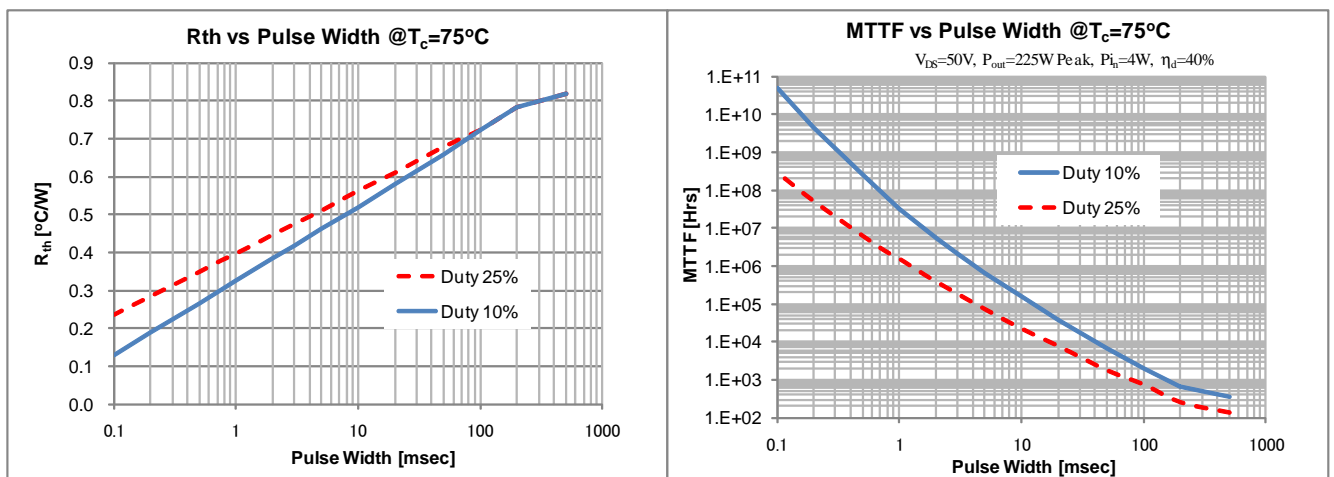


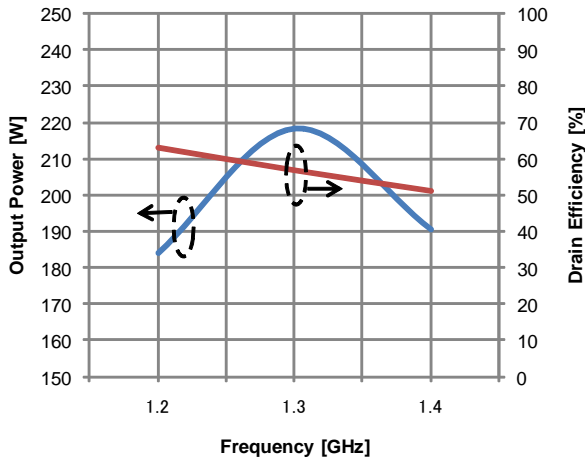
Figure 1. Transient Thermal Resistance vs Pulse Width @ $T_c = 75^\circ\text{C}$

Figure 2. MTF vs Pulse Width @ $T_c = 75^\circ\text{C}$
 $V_{DS}=50\text{V}$, $P_{out}=225\text{W peak}$, $P_{in}=4\text{W}$, $\eta_d=40\%$, $T_c=75^\circ\text{C}$

ESD characteristic

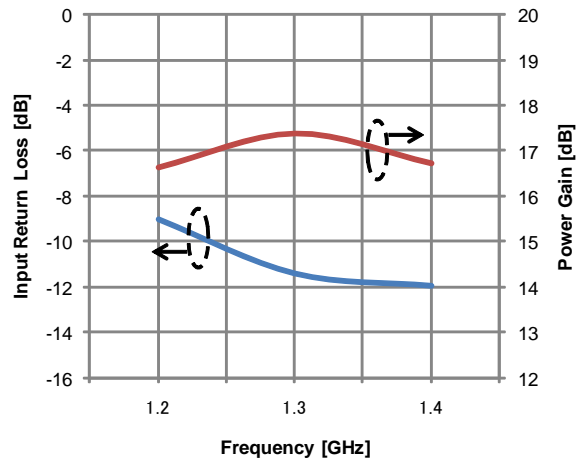
Test Methodology	Class
Human Body Model (per JESD22-A114)	1B
Machine Model (per JEIA/ESD22-A115)	B

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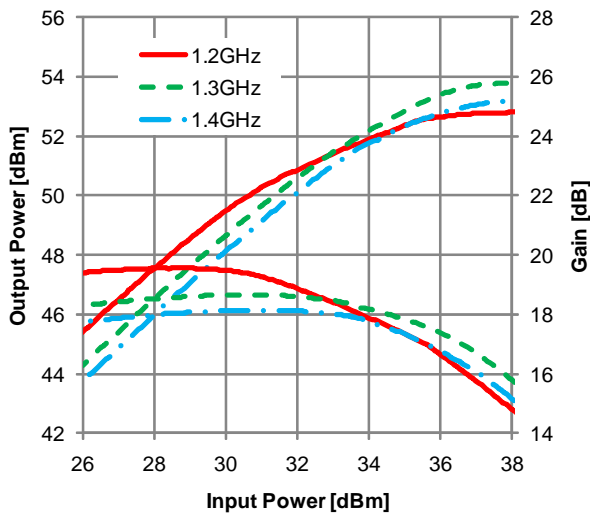
$V_{DS}=50V$, $I_{DS(DC)}=1A$, $P_{in}=4W$,
 $PW=200\mu\text{sec}$, Duty 10%

Figure 3. Output Power and Drain Efficiency vs Frequency



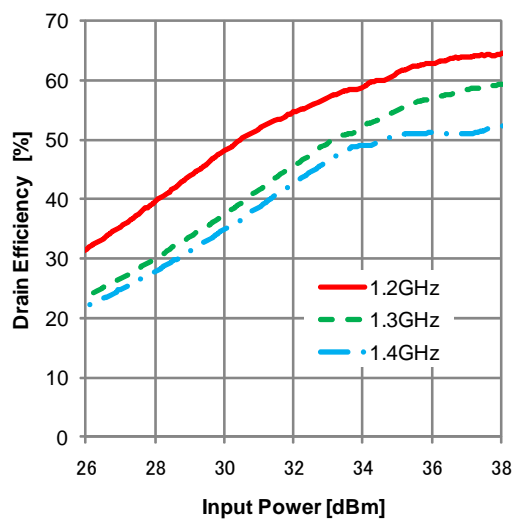
$V_{DS}=50V$, $I_{DS(DC)}=1A$, $P_{in}=4W$,
 $PW=200\mu\text{sec}$, Duty 10%

Figure 4. Input Return Loss and Power Gain vs Frequency



$V_{DS}=50V$, $I_{DS(DC)}=1A$,
 $PW=200\mu\text{sec}$, Duty 10%

Figure 5. Output Power and Gain vs Input Power



$V_{DS}=50V$, $I_{DS(DC)}=1A$,
 $PW=200\mu\text{sec}$, Duty 10%

Figure 6. Drain Efficiency vs Input Power



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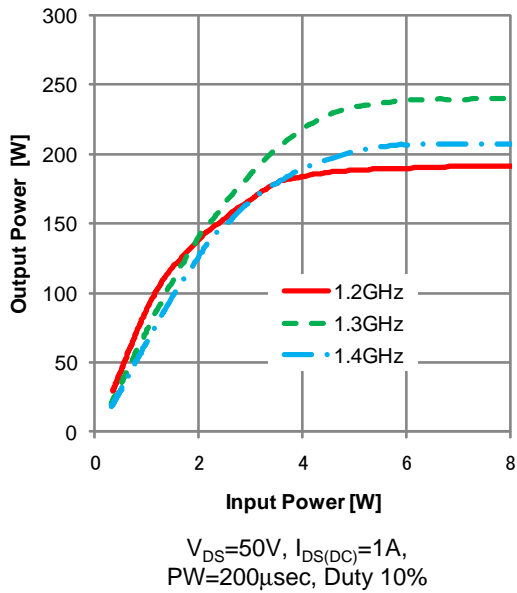


Figure 7. Output Power vs Input Power

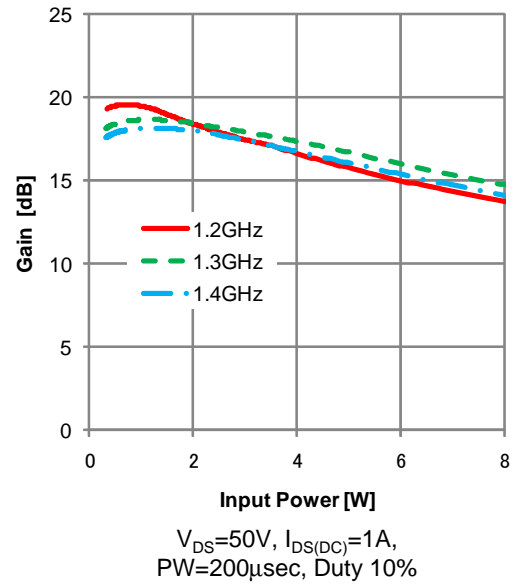


Figure 8. Gain vs Input Power

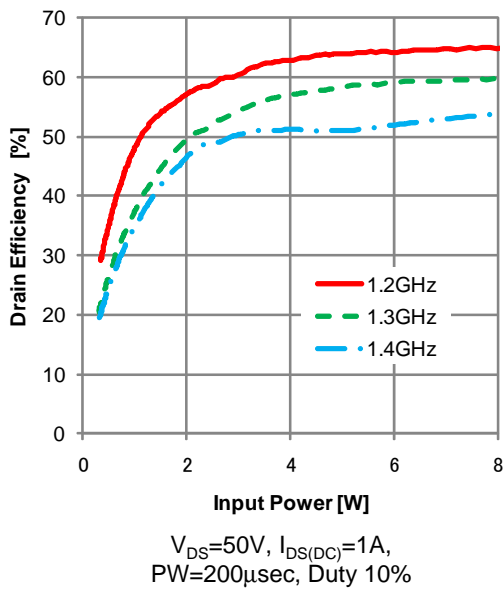


Figure 9. Drain Efficiency vs Input Power



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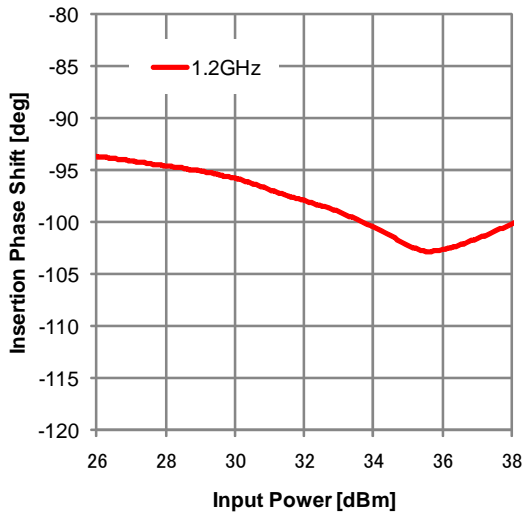


Figure 10. a) f=1.2GHz

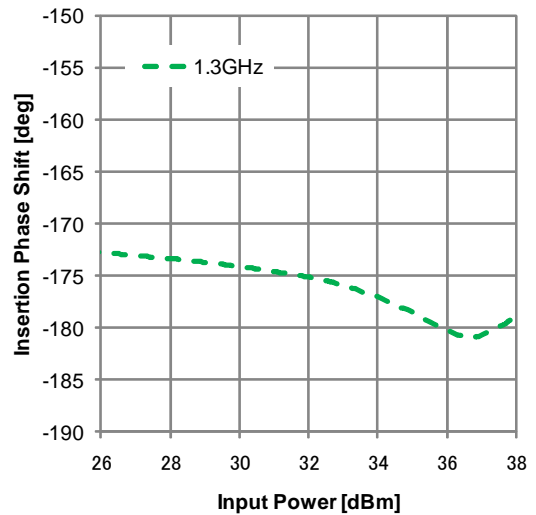


Figure 10. b) f=1.3GHz

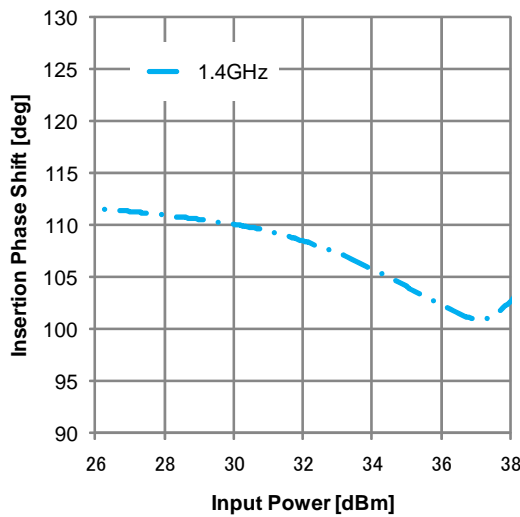


Figure 10. c) f=1.4GHz

$V_{DS}=50V$, $I_{DS(DC)}=1A$,
PW=200 μ sec, Duty 10%

Figure 10. Insertion Phase shift vs Input Power



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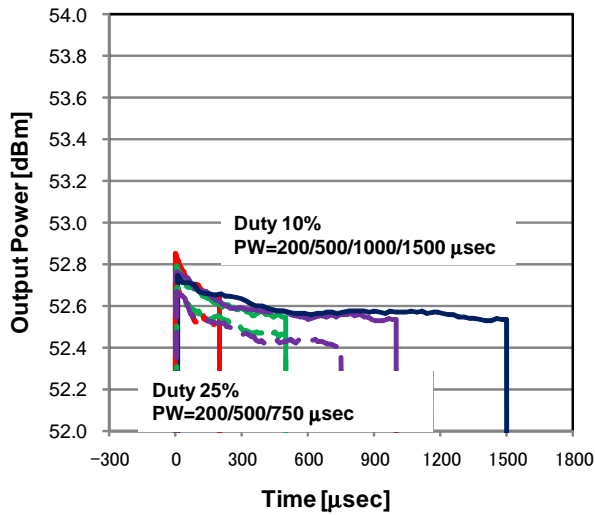


Figure 11. a) $f=1.2\text{GHz}$

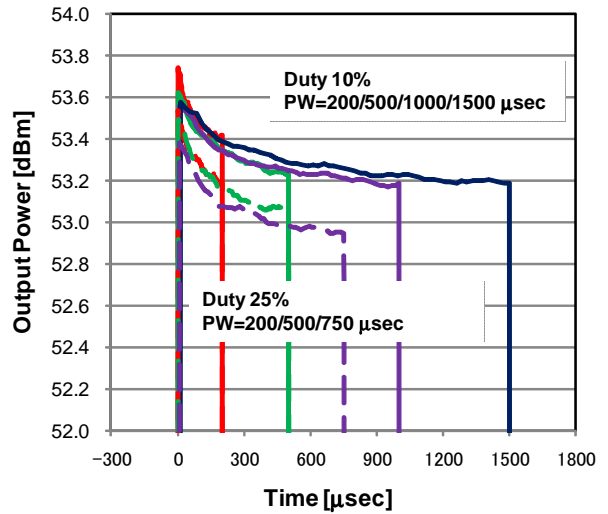


Figure 11. b) $f=1.3\text{GHz}$

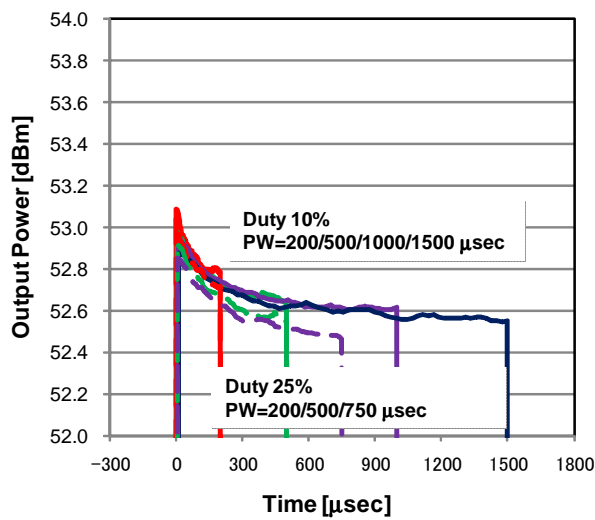


Figure 11. c) $f=1.4\text{GHz}$

$V_{DS}=50\text{V}$, $I_{DS(DC)}=1\text{A}$, $P_{in}=4\text{W}$
PW/Duty = 200/10, 500/10, 1000/10, 1500/10,
200/25, 500/25, 750μsec/25%

Solid Line : Duty 10%
Dashed Line : Duty 25%

Figure 11. Pulse Performance (Power) with various Pulse Condition

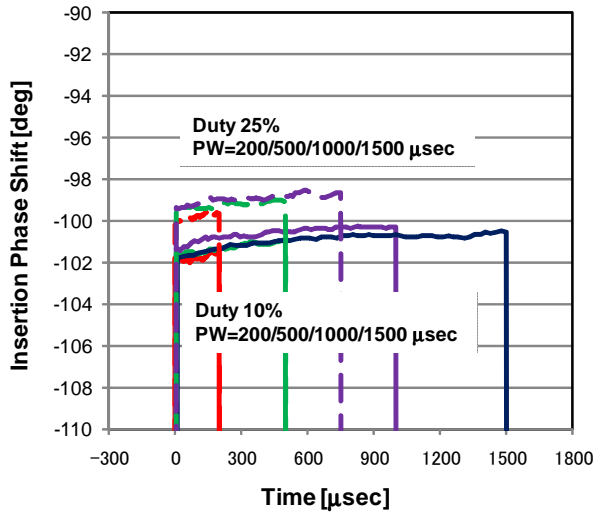


Figure 12. a) $f=1.2\text{GHz}$

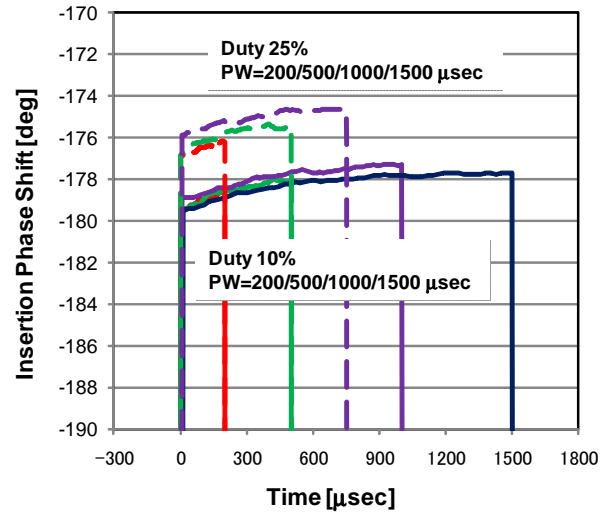


Figure 12. b) $f=1.3\text{GHz}$

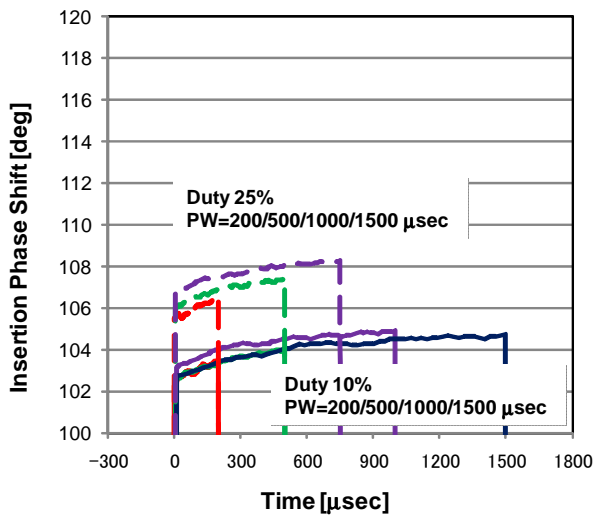


Figure 12. c) $f=1.4\text{GHz}$

$V_{DS}=50\text{V}$, $I_{DS(DC)}=1\text{A}$, $P_{in}=4\text{W}$
 PW/Duty = 200/10, 500/10, 1000/10, 1500/10,
 200/25, 500/25, 750 $\mu\text{sec}/25\%$

Solid Line : Duty 10%
 Dashed Line : Duty 25%

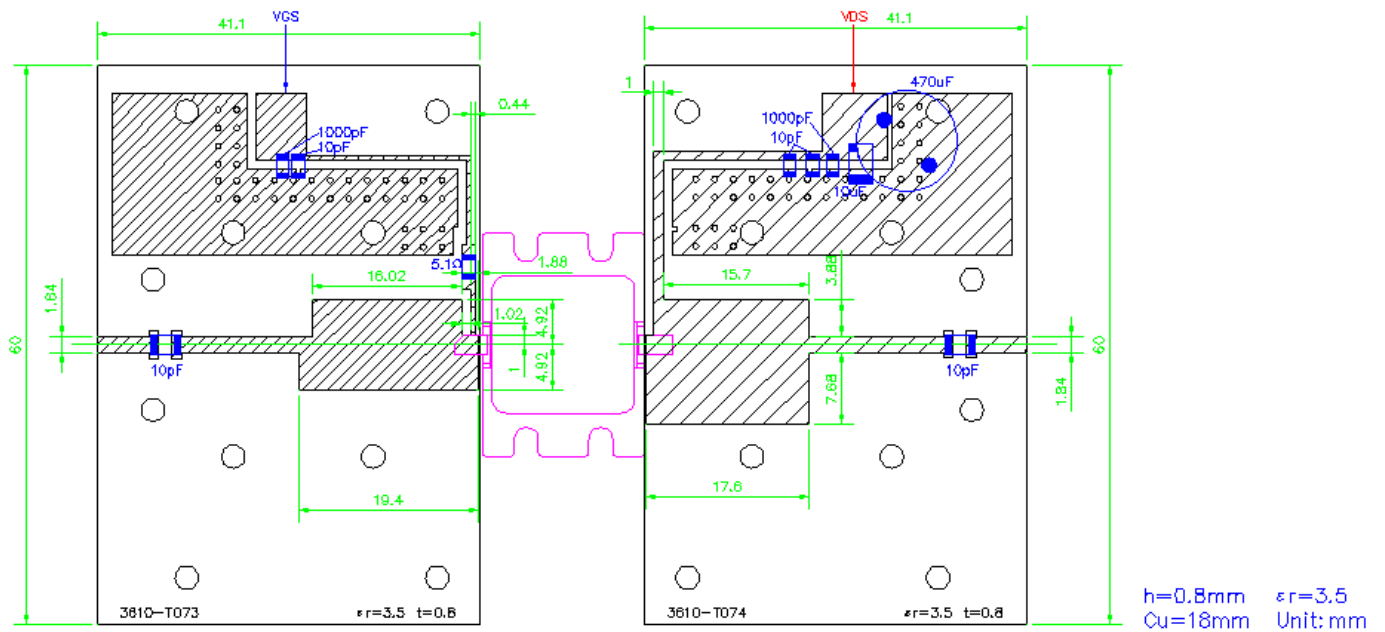
Figure 12. Pulse Performance
 (Insertion Phase Shift)
 with various Pulse Condition



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TEST FIXTURE





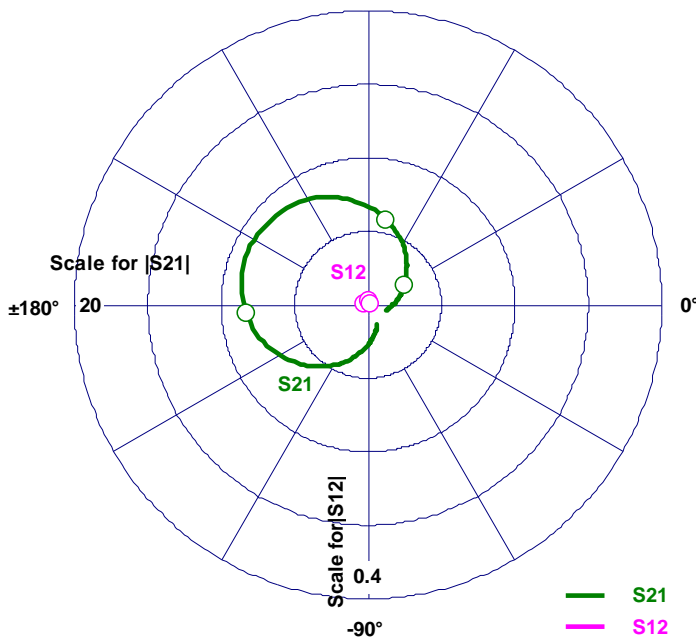
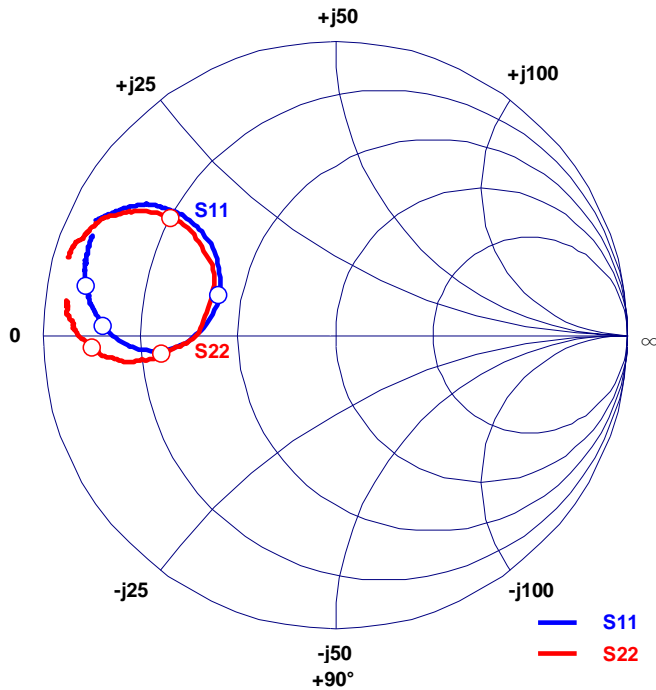
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S-parameters

@V_{DS}=50V I_{DS(DC)}=1A f=1.0 to 1.6GHz
 Z_l = Z_s = 50ohm Marker: 1.2, 1.3, 1.4GHz

Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
1.00	0.91	154.6	1.46	-66.1	0.00	-70.3	0.95	164.0
1.01	0.90	153.8	1.58	-68.5	0.00	-90.9	0.95	163.7
1.02	0.89	153.1	1.76	-71.9	0.00	-75.7	0.95	163.4
1.03	0.88	152.3	1.89	-74.7	0.00	-84.9	0.95	162.7
1.04	0.87	151.6	1.99	-77.1	0.00	-90.4	0.95	162.0
1.05	0.86	150.8	2.18	-80.7	0.00	-93.3	0.95	161.3
1.06	0.85	149.9	2.36	-84.0	0.00	-90.5	0.94	160.8
1.07	0.84	149.0	2.49	-86.6	0.00	-98.0	0.94	160.1
1.08	0.83	148.0	2.76	-90.7	0.00	-107.4	0.93	159.6
1.09	0.81	146.9	3.05	-95.1	0.00	-110.5	0.92	158.9
1.10	0.79	145.7	3.26	-98.6	0.00	-117.3	0.92	157.9
1.11	0.77	144.6	3.59	-103.8	0.00	-117.5	0.91	157.0
1.12	0.74	143.7	4.07	-110.4	0.00	-124.3	0.91	155.7
1.13	0.70	142.9	4.47	-116.2	0.00	-128.3	0.90	154.5
1.14	0.67	142.1	4.87	-122.0	0.00	-140.2	0.89	153.2
1.15	0.62	142.0	5.44	-129.4	0.00	-142.6	0.87	152.0
1.16	0.58	142.3	6.01	-137.2	0.00	-152.7	0.84	150.7
1.17	0.53	143.9	6.59	-145.1	0.00	-163.5	0.81	149.1
1.18	0.48	147.5	7.27	-155.3	0.00	-172.1	0.78	147.1
1.19	0.44	153.6	7.88	-165.9	0.01	-179.2	0.74	145.8
1.20	0.42	161.0	8.27	-175.8	0.01	168.3	0.69	144.6
1.21	0.43	170.6	8.70	-171.8	0.01	158.6	0.63	144.1
1.22	0.46	178.3	8.97	-159.3	0.01	147.2	0.56	145.9
1.23	0.52	-177.1	8.92	147.6	0.01	133.5	0.50	149.4
1.24	0.57	-175.2	8.73	135.8	0.01	120.2	0.46	155.6
1.25	0.64	-175.1	8.44	124.0	0.01	109.7	0.44	164.1
1.26	0.68	-176.3	8.00	113.5	0.01	101.9	0.45	171.9
1.27	0.72	-177.7	7.47	103.6	0.01	86.9	0.47	178.9
1.28	0.75	-179.4	6.98	94.7	0.01	78.9	0.51	-177.0
1.29	0.78	-179.2	6.48	86.2	0.01	75.0	0.56	-175.2
1.30	0.79	-177.7	5.93	78.2	0.01	66.9	0.60	-173.6
1.31	0.81	-176.5	5.48	71.0	0.01	59.0	0.63	-172.6
1.32	0.82	-175.2	5.06	64.5	0.00	54.7	0.67	-172.8
1.33	0.83	-174.4	4.61	58.1	0.00	47.1	0.70	-172.6
1.34	0.84	-173.5	4.23	52.6	0.00	40.7	0.73	-172.6
1.35	0.85	-172.6	3.95	48.3	0.00	38.4	0.75	-173.7
1.36	0.85	-171.7	3.66	43.9	0.00	36.3	0.77	-174.5
1.37	0.85	-170.9	3.37	39.5	0.00	29.6	0.79	-174.7
1.38	0.86	-170.1	3.17	35.8	0.00	30.8	0.81	-175.7
1.39	0.86	-169.4	3.00	32.3	0.00	31.1	0.82	-176.6
1.40	0.87	-169.0	2.75	27.8	0.00	30.3	0.83	-177.1
1.41	0.87	-168.4	2.62	24.7	0.00	24.2	0.84	-177.7
1.42	0.87	-167.8	2.50	21.7	0.00	27.4	0.85	-178.4
1.43	0.88	-167.2	2.33	17.9	0.00	26.0	0.87	-179.1
1.44	0.88	-166.7	2.20	14.7	0.00	22.5	0.88	-179.7
1.45	0.89	-165.9	2.14	12.4	0.00	19.3	0.89	-179.5
1.46	0.89	-165.4	2.05	9.9	0.00	16.8	0.89	-178.9
1.47	0.89	-164.8	1.92	6.9	0.00	17.1	0.90	-178.5
1.48	0.89	-164.2	1.84	4.8	0.00	15.9	0.90	-178.0
1.49	0.89	-163.8	1.78	2.8	0.00	19.6	0.90	-177.5
1.50	0.89	-163.4	1.66	-0.3	0.00	16.2	0.90	-177.1
1.51	0.89	-162.8	1.62	-2.0	0.00	11.8	0.91	-176.7
1.52	0.89	-162.3	1.58	-4.0	0.00	19.1	0.91	-176.1
1.53	0.89	-161.9	1.50	-6.2	0.00	14.0	0.92	-175.5
1.54	0.90	-161.3	1.44	-8.1	0.00	13.4	0.92	-175.1
1.55	0.90	-160.8	1.45	-9.2	0.00	10.2	0.92	-174.7
1.56	0.90	-160.2	1.42	-10.7	0.00	14.1	0.92	-174.5
1.57	0.90	-159.7	1.37	-12.5	0.00	8.7	0.92	-174.3
1.58	0.90	-159.1	1.37	-13.9	0.00	9.5	0.92	-173.9
1.59	0.90	-158.6	1.36	-15.4	0.00	11.5	0.92	-173.5
1.60	0.90	-158.0	1.30	-17.9	0.00	10.0	0.93	-172.8

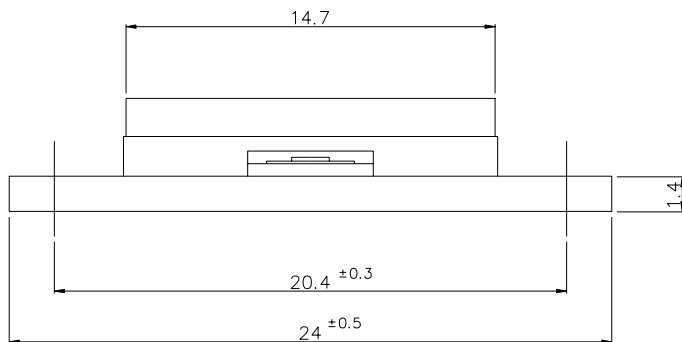
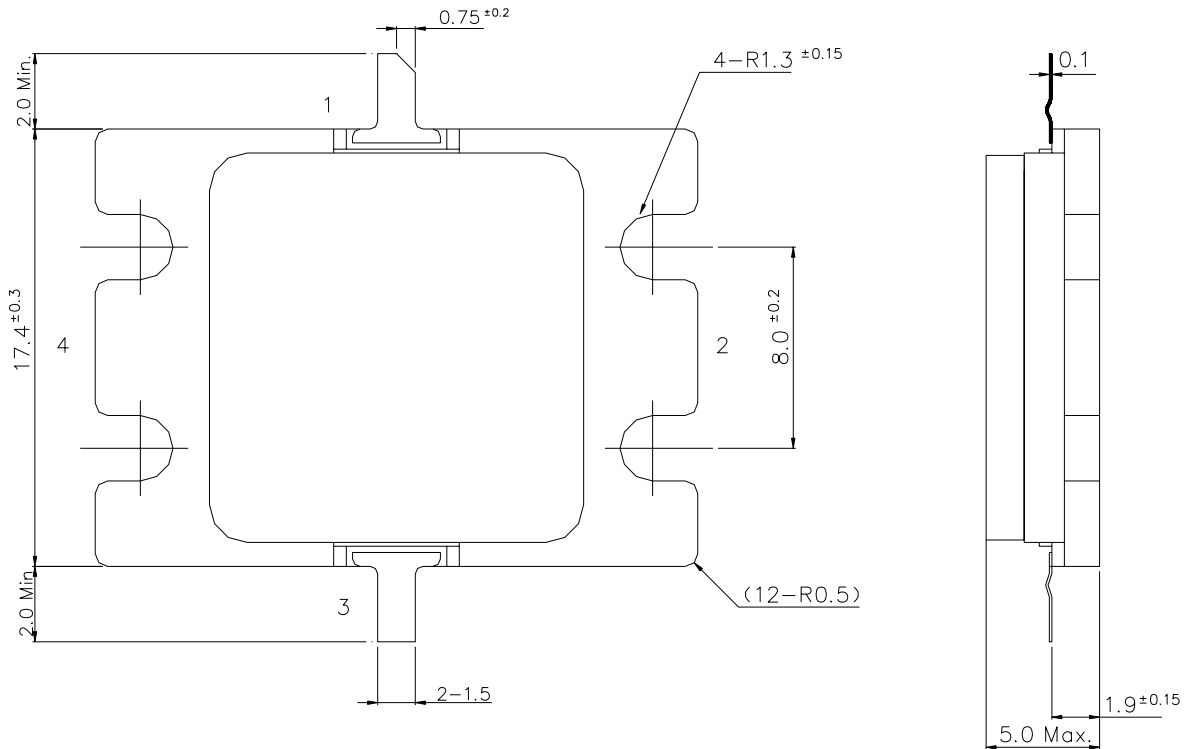




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IV Package Outline Metal-Ceramic Hermetic Package



- 1 : Gate
 - 2 : Source(Flange)
 - 3 : Drain
 - 4 : Source(Flange)
- Unit : mm



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High Voltage - High Power GaN-HEMT for Radar

For further information please contact:

<http://global-sei.com/Electro-optic/about/office.html>

CAUTION

Sumitomo Electric Device Innovations, Inc. products contain **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put these products into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.